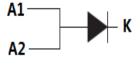


#### **Main Product Characteristics:**

IF	20A
VRRM	100V
T <sub>j</sub> (max)	<b>150</b> ℃
Vf(max)	0.85V





TO252 SSTS20100D

**Schematic Diagram** 

#### **Features and Benefits:**

- High Junction Temperature
- High ESD Protection
- High Forward & Reverse Surge capability



## **Description:**

Schottky Barrier Rectifier designed for high frequency switch model power supplies such as adaptors and DC/DC convertors; this product special design for high forward and reverse surge capability.

## **Absolute Rating:**

Symbol	Characterizes	Value	Unit
$V_{RRM}$	Peak Repetitive Reverse Voltage	100	V
$V_{R(RMS)}$	RMS Reverse Voltage	70	V
I <sub>F(AV)</sub>	Average Forward Current	20	Α
I <sub>FSM</sub>	Non Repetitive Surge Forward Current(tp=8.3ms sinusoidal)	150	Α
I <sub>RRM</sub>	Peak Repetitive Reverse Surge Current(Tp=2us)	2	А
$T_J$	Maximum operation Junction Temperature Range	-55~150	$^{\circ}\!\mathbb{C}$
T <sub>stg</sub>	Storage Temperature Range	-55~150	$^{\circ}\!\mathbb{C}$

### **Thermal Resistance**

Symbol	Characterizes	Value	Unit	
$R_{\theta JC}$	Maximum Thermal Resistance Junction To Case	TO252	2	°C/W
$R_{ heta JC}$	(per leg)	10252	2	C/VV

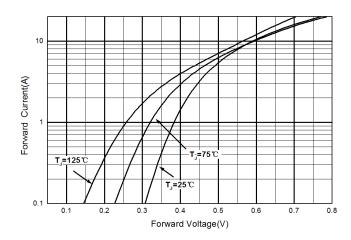
## **Electrical Characterizes** @T<sub>A</sub>=25℃ unless otherwise specified

Symbol	Characterizes	Min	Тур	Max	Unit	Test Condition
$V_R$	Reverse Breakdown Voltage	100			<b>V</b>	I <sub>R</sub> =0.5mA
V	V Familiard Valtage Drag			0.85	V	I <sub>F</sub> =20A, T <sub>J</sub> =25℃
V <sub>F</sub> Forward Voltage Drop				0.78		I <sub>F</sub> =20A, T <sub>J</sub> =125℃
L Joskogo Current				0.2	mΛ	V <sub>R</sub> =100V, T <sub>J</sub> =25℃
I <sub>R</sub>	Leakage Current			50	mA	V <sub>R</sub> =100V, T <sub>J</sub> =125℃

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# I-V Curves:



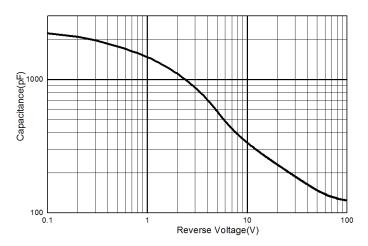


Figure 2: Typical Capacitance Characteristics Figure 1: Typical Forward Characteristics

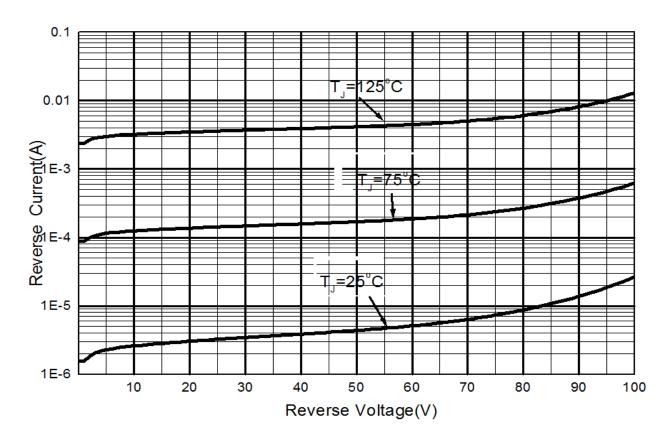
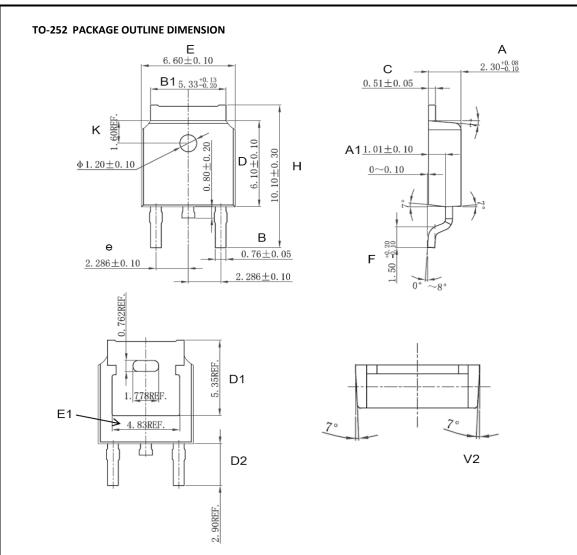


Figure 3: Typical Reverse Characteristics



# **Mechanical Data:**



Compleal	Dimension In Millimeters			Dimension In Inches			
Symbol	Min	Nom	Max	Min	Nom	Max	
Α	2.200	2.300	2.380	0.087	0.091	0.094	
A1	0.910	1.010	1.110	0.036	0.040	0.044	
В	0.710	0.760	0.810	0.028	0.030	0.032	
B1	5.130	5.330	5.460	0.202	0.210	0.215	
С	0.460	0.510	0.560	0.018	0.020	0.022	
D	6.000	6.100	6.200	0.236	0.240	0.244	
D1		5.350 (REF)			0.211 (REF)		
D2		2.900 (REF)		0.114 (REF)			
E	6.500	6.600	6.700	0.256	0.260	0.264	
E1		4.83 (REF)			0.190 (REF)		
е	2.186	2.286	2.386	0.086	0.090	0.094	
Н	9.800	10.100	10.400	0.386	0.398	0.409	
F	1.400	1.500	1.700	0.055	0.059	0.067	
K	1.600 (REF)			0.063 (REF)			
V2	8° (REF)				8 <sup>0</sup> (REF)		



**Ordering and Marking Information** 

**Device Marking: SSTS20100D** 

Package (Available)
TO-252
Operating Temperature Range
C:-55 to 150 °C

# **Devices per Unit**

### Option1:

Package	Units/Tap	Tapes/Inner	Units/Inner	Inner	Units/Carton
Type	e	Box	Box		Box
				Box	
TO-252	2500	2	5000	7	35000

## Option2:

Package	Units/Tap	Tapes/Inner	Units/Inner	Inner	Units/Carton
Type	e	Box	Box	Boxes/Carton	Box
				Box	
TO-252	2500	1	2500	10	25000

# **Reliability Test Program**

Test Item	Conditions	Duration	Sample Size
High	Tj=125℃ to 150℃ @	168 hours	3 lots x 77 devices
Temperature	80% of Max	500 hours	
Reverse	VDSS/VCES/VR	1000 hours	
Bias(HTRB)			

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